

CCM02-MKI-ROHS

Ref./ PS-CCM02-MKI-1

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ISSUE 1 – Rev. B: SEPTEMBER 2008

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Note

This specification, attached documents and attached drawings cannot be communicated to anybody without written agreement of C&K.



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Revision record:

Revision	Date	Comments
Issue 1	May 2 nd , 2006	Creation
Issue 1 – Rev. A	August 8 th , 2007	Update:
		Soldering process
		Solderability: temperature & spec reference
		(according to ECR 628)
		Resistance to fluids : comment added
		(according to ECR 1186)
Issue 1 – Rev. B	September 4 th , 2008	Update:
		UL data suppressed
		(according to ECR 2324)
		Reference of test specifications updated
		(according to ECR 2446)



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SUMMARY

Preliminary / versions covered by this sp	pecificatio	n
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- 1. Description
- 2. Physical data
- 3. Using temperatures
- 4. Electrical data
- 5. Mechanical data
- 6. Additional data: storage and handling environment
- 7. Additional data: process environment
- 8. Additional data: operating environment
- 9. Additional data: Applicable norms
- 10. Qualification Plan



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VERSIONS COVERED BY THIS SPECIFICATION

Reference	Drawing N°	Cts number	Switch
CCM02-1NO-3 RoHS	CU 030288Y0207	2 x 4 cts	NO (normally open) Dust sealed switch
CCM02-1NO-32 RoHS	CU 030288Y0209	2 x 4 cts	NO (normally open) Dust sealed switch
CCM02-2NO-32 RoHS	CU 030288Y0215	2 x 8 cts	NO (normally open) Dust sealed switch
CCM02-0NO-503 RoHS	CU 030288Y0503	2 x 3 cts	NO (normally open) Dust sealed switch



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1 - Description





Product group: CCM02

Product Sub Family: Mk1

ROHS Compliance

Card type: Full-sized card

Contact type: Landing

Contact plating: Selective gold

Contacts number: see table p. 4

Terminal type: Thru-hole

Card end travel switch: see table

p. 4

Generic specification (C&K):

Proc. essai 20

2 – <u>Physical data</u>		
Mass	6 g ± 2.0	
Dimensions & lay out	According to drawing : see table page 4	
3 – <u>Using temperatures</u>		
Operating temperatures	- 40 °C / + 85 °C	
Storage temperatures	- 40 °C / + 85 °C	
4 - Electrical data		
Voltage / ct	≤ 5 Vdc	
Current / ct	≤ 10 mA	
Contact resistance	$\leq 100 \text{ m}\Omega$	
Voltage proof	≥ 750 Vrms	
	Initial measurement $\geq 1000 \text{ M}\Omega \text{ (100 VDC)}$	
Insulation resistance	After damp heat $\geq 1 \text{ M}\Omega$ recovery time : 4 hours	
	After damp heat $\geq 200 \text{ M}\Omega$ recovery time : 24 hours	
Card and traval switch chara	otoristics :	

Card end travel switch characteristics:

-	Max power	0.2 VA
-	Max voltage	30 Vdc

- Min/Max current 50 μA min / 10 mA max

- Bounces $\leq 0.5 \text{ ms}$

Voltage proof $\geq 750 \text{Vrms}$ between signal contact / switch contacts $\geq 250 \text{Vrms}$ between open contacts of the switch

Insulation resistance Initial measurement $\geq 1000 \text{ M}\Omega \text{ (100 VDC)}$

After damp heat $\geq 1 \text{ M}\Omega$ recovery time: 4 hours After damp heat $\geq 200 \text{ M}\Omega$ recovery time: 24 hours between signal contact / switch contacts &

between signal contact \slash switch contacts & between open contacts of the switch

- Contact resistance ≤ 100 mΩ

Card end travel switch card end travel switch activates when the sliding sequence card is 1.0 mm from the card stop.

5 – <u>Mechanical data</u> Card insertion force

Card insertion force 10 N max

Card withdrawal force 1N min / 10 N max

Contact force (end travel switch) 0.8 N max to activate the switch 1.8 N max for complete depression

6 - Additional data : storage and handling environment

Marking & TraceabilityDesignation : according to drawing Date code : year / weekPackaging conditions30 samples per tray / 10 trays per boxSea-air-land / World wide / High $\leq 5 \text{ m}$ Transport conditions $30^{\circ}\text{C} / 85\% \text{ HR}$

According to H00-060

7 - <u>Additional data : process environment</u>

Soldering process

Solder heat resistance

Solder heat resistance

260°C / 5 sec. According to IEC 60068-44

Static load (transverse)

(CCM / PCB)

According to IEC 512-5 test 8a/8b



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Terminal robustness	1 bend / 45° / forward & back According to IEC 60068-2-21 test Ub method 1			
Contact retention in insert	2 N / 10sec./ displacement < 0.3 mm According to IEC 512-8 test 15a			
Solderability (wetting balance)	235°C According to IEC 60068-2-69			
Dust sealed test (only for switch)	Dust test / IP5x According to IEC 60529:1989/A1:1999			
Resistance to fluids	The product is not compatible with washing process.			
8 – Additional data: operating	environment			
Operating life	≥ 100 000 cycles			
Vibration	$10-500 \text{ Hz} / 50 \text{ m/s}^2 / 3 \text{ axis} / 2 \text{ hours per axis}$ No discontinuity $> 1 \mu \text{s}$ According to IEC 60068-2-6.			
Mechanical shock	$500 \text{ m/s}^2 / \frac{1}{2} \text{ sinusoidal } / 11 \text{ ms}$ 3 shocks in the 2 directions of the 3 axis No discontinuity > 1 μ s According to IEC 60068-2-27.			
Rapid change of temperature	100 cycles / - 40°C / + 85°C According to IEC60068-2-14, test Nb			
Climatic sequence	Dry heat: 85°C / 16 hours Damp heat: 1 cycle 24hours 55°C & 93% HR Cold: -40°C / 2 hours Damp heat: 1 cycle 24hours 55°C & 93% HR According to IEC 60068-2-61, test Z/ABDM			
Dry heat storage	85°C / 250 hours According to IEC 60068-2-2, test Bb.			
Damp heat storage	40°C / 93% HR / 10 days According to IEC 60068-2-78 test Cab			
Corrosion	96 hours / salt spray According to IEC 60068-2-11, test Ka.			
The environmental tests can be cumulative according to the qualification file				
9 - Additional data : applicable norms				
Legal norm (EHS) ITT procedure				
Warranty period	1 year			
10– Qualification Plan				
According to PROC-20				